

Enhanced Long-Term Stability of Crystalline Nickel–Boride (Ni_{23}B_6) Electrocatalyst by Encapsulation with Hexagonal Boron Nitride

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Nickel boride catalysts show great potential as low-cost and efficient alternatives to noble-metal catalysts in acidic media; however, synthesizing and isolating a specific phase and composition of nickel boride is nontrivial, and issues persist in their long-term stability as electrocatalysts. Here, a single-crystal nickel boride, Ni_{23}B_6 , is reported which exhibits high electrocatalytic activity for the hydrogen evolution reaction (HER) in an acidic solution, and that its poor long-term stability can be overcome via encapsulation by single-crystal trilayer hexagonal boron nitride (hBN) film. Interestingly, hBN-covered Ni_{23}B_6 on a Ni substrate shows an identical overpotential of 52 mV at a current density of 10 mA cm^{-2} to that of bare Ni_{23}B_6 . This phenomenon indicates that the single-crystalline hBN layer is catalytically transparent and does not obstruct HER activation. The hBN/ Ni_{23}B_6 /Ni has remarkable long-term stability with negligible changes to its polarization curves for 2000 cycles, whereas the Ni_{23}B_6 /Ni shows significant degradation after 650 cycles. Furthermore, chronoamperometric measurements indicate that stability is preserved for >20 h. Long-term stability tests also reveal that the surface morphology and chemical structure of the hBN/ Ni_{23}B_6 /Ni electrode remain preserved. This work provides a model for the practical design of robust and durable electrochemical catalysts through the use of hBN encapsulation.

1. Introduction

Nickel borides are promising catalysts for a broad range of reactions, including hydrogenation, the hydrogen evolution reaction (HER), and the oxygen evolution reaction (OER).^[1,2] However, many different nickel boride compounds exist, exhibiting various phase and chemical compositions; examples include amorphous nickel borides and crystalline NiB, Ni_3B , Ni_2B , Ni_4B_3 , Ni_7B_3 , and Ni_{23}B_6 .^[3–5] When synthesized by heat treatment, the ultimate phase and composition of the nickel boride compounds are typically determined by reaction temperature, duration time, and cooling rate.^[3,6] Unfortunately, most synthesis processes of nickel boride compounds generate mixed crystalline and amorphous phases. In these mixtures, the catalytic activity of the nickel borides can be varied by the ratio of the amorphous to crystalline phases; the amorphous phases are highly active catalysts for hydrogenation and other organic reactions.^[3,7] Amorphous

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nickel boride and crystalline Ni₃B have also been studied as catalysts for HER.^[5,8,9] When amorphous nickel boride is combined with metal nanoparticles, significant enhancement of the catalytic activity is observed, relative to that of the amorphous phase alone.^[8,9] As for crystalline Ni₃B, it is porous, and its catalytic performance is highly dependent on the amount of active surface area exposed to the electrolytes.^[5]

Due to the easily formed product mixtures of nickel boride syntheses, the intrinsic properties of pure single-crystalline nickel borides remain elusive.^[6] Among the many nickel boride phases, Ni₂₃B₆ is one of the best defined structures; it is the only face-centered cubic (FCC) structure,^[10] and thus can be epitaxially formed on Ni without any structural deformation.^[11] Ni₂₃B₆ exhibits a metallic property that is expected to render it a good electrochemical catalyst among the metal-rich nickel boride compounds^[12]; however, the synthesis of Ni₂₃B₆ is limited to the undercooling method with nucleation control,^[13] and its applicability to catalysis is currently unknown. Furthermore, thermodynamically metastable Ni₂₃B₆ would be unstable during electrochemical reactions^[14,15] because catalysts containing transition metals may have stability issues.^[16] One strategy for minimizing activity degradation during long-term catalytic operations would be the use of encapsulation, where a protective layer is added to shield and/or passivate the catalyst from unwanted reactions while allowing (and possibly assisting) catalytic activity.

2D materials, such as graphene and hexagonal boron nitride (hBN), have been intensively considered as efficient encapsulation materials.^[17–22] In fact, the literature includes reports of improved lifetimes for covered electrodes in a variety of electrochemical systems, including catalysts,^[23] molecular transport membranes,^[24] batteries,^[25] biosensors,^[26] and other electrochemical devices.^[27] Despite the negligible electrochemical catalytic activity of hBN, it has gained significant attention in investigations involving the oxygen reduction reaction (ORR), hydrogen oxidation reaction (HOR), OER, CO oxidation reaction, and methanation reaction.^[28–32] Metal catalysts for these electrochemical reactions have been reported to show improved catalytic activity and stability after they have been encapsulated by a defective layer of hBN, where reaction molecules can pass through pores, entering confined nanoreactors located between the metal and the hBN shell.^[28–32] In addition to its support functionality, hBN improved the catalytic activity of noble metals by modifying their charge-transfer properties.^[33,34] Ideally, highly crystalline hBN prevents the permeation of liquids and gases except for that of protons,^[35] but it has been shown to be transparent to atomic interactions such as van der Waals and electron-transfer interactions.^[36] Such a chemically transparent barrier is attractive for the long-term stability of electrochemical catalysts. Although theoretical and experimental studies of graphene encapsulation layers reveal them to be chemically transparent, to be able to maintain activity, and to enhance the stability of electrochemical catalysts,^[17,19] experimental investigations of hBN encapsulation layers of high crystallinity and with minimal or no defects have not yet been reported. Unsurprisingly, there is a lack of mechanistic studies on how the defects of the encapsulating hBN affect catalysis.

In this work, we report a highly stable electrocatalyst for HER; it consists of Ni₂₃B₆ supported on a Ni substrate and encapsulated by a hBN layer (hBN/Ni₂₃B₆/Ni). Without the hBN layer, Ni₂₃B₆

is unstable in the presence of HER. The hBN-covered Ni₂₃B₆ is formed following the growth of a single-crystal hBN layer on Ni(111) foil using a chemical vapor deposition (CVD) method.^[11] Ni(111) is indeed critical to the large-area growth of a uniform single-crystalline hBN trilayer film. The structure of Ni(111) promotes the epitaxial growth of unidirectionally aligned hBN islands, which subsequently form a continuous film. Additionally, the significant solubility of boron in Ni substrate plays a crucial role in facilitating single-crystalline hBN films.^[11] Other substrates have also been explored for the growth of large-area single-crystalline hBN films. For instance, liquid Au,^[22] Cu(110),^[37] and Cu(111)^[38] have been used. However, the hBN growth on Au and Cu substrates is typically limited to the monolayer films due to their negligible solubility for boron and nitrogen. The polarization curve and Tafel slope of hBN/Ni₂₃B₆/Ni electrodes show that catalytic activity is not impeded by the atomically thin hBN layers. Stability tests show that the hBN/Ni₂₃B₆/Ni electrodes maintain their catalytic performance after 20 h in the acidic electrolyte, indicating that the hBN/Ni₂₃B₆/Ni electrode is more stable than the uncovered Ni₂₃B₆/Ni electrode. This work demonstrates the high catalytic activity of Ni₂₃B₆ and the electrochemically transparent encapsulation effects of single-crystalline trilayer hBN film over a metal boride electrochemical catalyst for enhanced HER stability.

2. Results and Discussion

2.1. Fabrication and Characterization of hBN/Ni₂₃B₆/Ni Electrodes

Single-crystalline hBN encapsulating Ni₂₃B₆ on a Ni(111) substrate, abbreviated as hBN/Ni₂₃B₆/Ni, was prepared according to a previous report^[11] (see details in the Experimental Section). Briefly, single-crystalline trilayer hBN films were grown on single-crystalline Ni(111) foils over a large area using a CVD method, and during cooling, a Ni₂₃B₆ layer formed directly beneath the hBN film by the reaction of dissolved B atoms with the Ni(111) substrate. Characterization of the single-crystal hBN films was performed after transferring them to SiO₂ (300 nm)/Si substrates. Optical microscopy reveals uniform contrast over the entire area of the hBN film, indicating thickness uniformity over a large area (Figure S1a, Supporting Information). The line scan from atomic force microscopy (AFM) shows that the thickness of the transferred film is ≈1.2 nm (Figure S1b, Supporting Information). A typical Raman spectrum shows the E_{2g} mode from hBN at 1368 cm⁻¹ with a full width at half-maximum (FWHM) of ≈14 cm⁻¹ (Figure S1c, Supporting Information); this is comparable to that reported for a single-crystalline hBN monolayer.^[37] X-ray photoelectron spectroscopy (XPS) measurements indicate sp²-hybridized B and N bonds in the hBN film. The B:N atomic ratio was found to be 1:0.96, calculated from peaks at 189.9 eV (in the binding-energy region of B 1s) and 397.6 eV (N 1s) (Figure S1d, Supporting Information). The structure of the single-crystalline hBN/Ni₂₃B₆/Ni is described in Figure 1a, and it is consistent with the cross-sectional transmission electron microscopy (TEM) images (Figure 1b–d). The Ni₂₃B₆ layer shows a uniform thickness of 200 nm on the surface of Ni(111) (Figure 1c) and the elemental distributions of Ni, B, and N were performed by energy-filtered TEM imaging (Figure S2, Supporting Information). Its structure was determined using

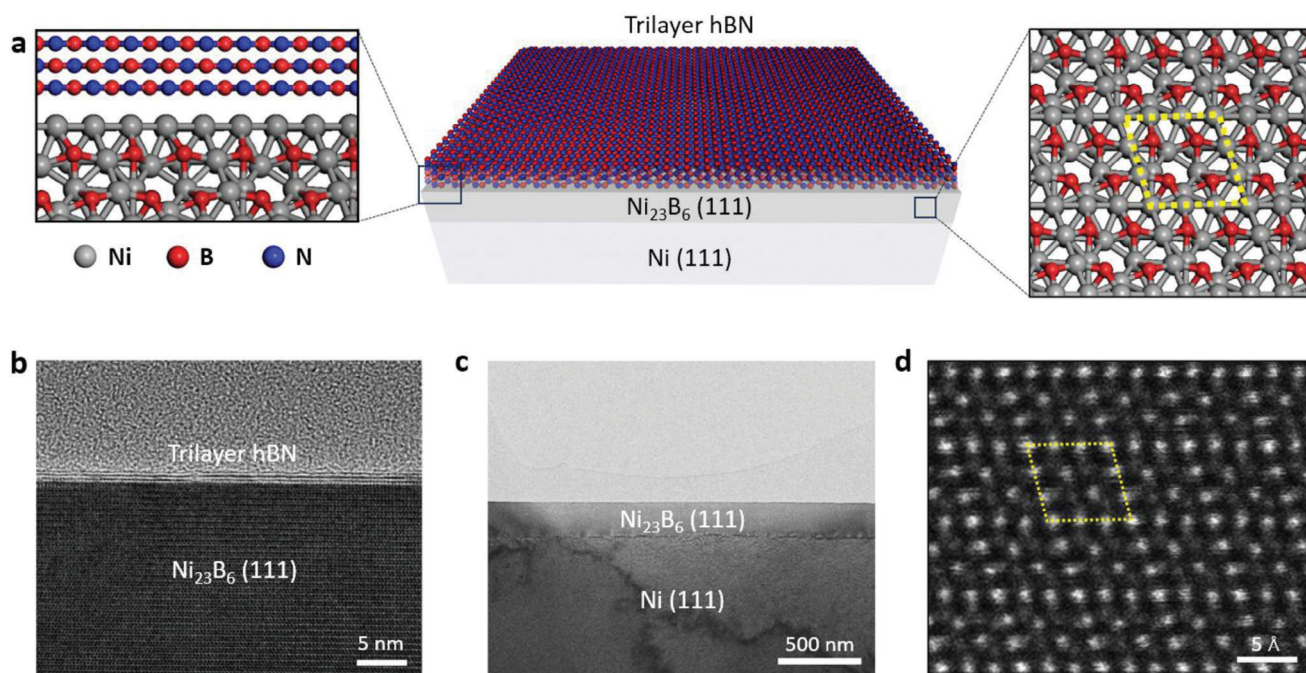


Figure 1. Single-crystalline trilayer hBN film covering the Ni_{23}B_6 cathode. a) Schematic illustrations of the cathode comprising trilayer hBN/ Ni_{23}B_6 layers on Ni(111) foil. Left zoomed-in schematic shows the interface between the trilayer hBN and Ni_{23}B_6 (111), including a legend for the elements present. Right zoomed-in schematic shows the structure of the Ni_{23}B_6 layer; yellow dots outline a unit cell. b) High- and c) low-magnification TEM images of the trilayer hBN/ Ni_{23}B_6 /Ni(111). d) Annular dark-field STEM image of Ni_{23}B_6 at the [110] zone axis. Yellow dots indicate a unit cell of Ni_{23}B_6 .

annular dark-field scanning TEM (STEM) (Figure 1d); Ni_{23}B_6 has a face-centered cubic structure (space group $Fm\bar{3}m$) with a lattice constant of $a = 10.76 \text{ \AA}$, which is three times larger than that of Ni ($a = 3.54 \text{ \AA}$), enabling their epitaxial relationship (Figures S3 and S4, Supporting Information).

2.2. HER Performance and Stability of hBN/ Ni_{23}B_6 /Ni Electrode

We evaluated the HER performance of the hBN-covered Ni_{23}B_6 catalyst in H_2SO_4 solutions. To avoid exposure of the supporting Ni substrate, the edge of the electrode was masked with an electrochemically inert polytetrafluoroethylene (PTFE) adhesive tape, ensuring that the solution only made contact with

hBN-covered Ni_{23}B_6 . A bias potential V_{RHE} (potential with respect to the reversible hydrogen electrode, RHE) was applied between the hBN/ Ni_{23}B_6 /Ni electrode and a graphite electrode. Figure 2a shows the typical current–voltage behavior for HER. The recorded current density j reached -10 mA cm^{-2} at an overpotential of η of 52 mV (where $\eta = V_{\text{RHE}} + 0.213 \text{ V}$, the theoretical equilibrium potential for water electrolysis), and it increases quickly with V_{RHE} at a slope of close to 42 mV dec^{-1} , which is also known as the Tafel slope (Figure 2b). As a result, the j reaches up to -100 mA cm^{-2} at $\eta \approx 170 \text{ mV}$.

For comparison, we also measured HER performance of pristine Ni_{23}B_6 /Ni, Ni(111), and Pt electrodes; to the best of our knowledge, this is the first report on the activity of Ni_{23}B_6 for HER. Pristine Ni_{23}B_6 was prepared by removing the hBN layer

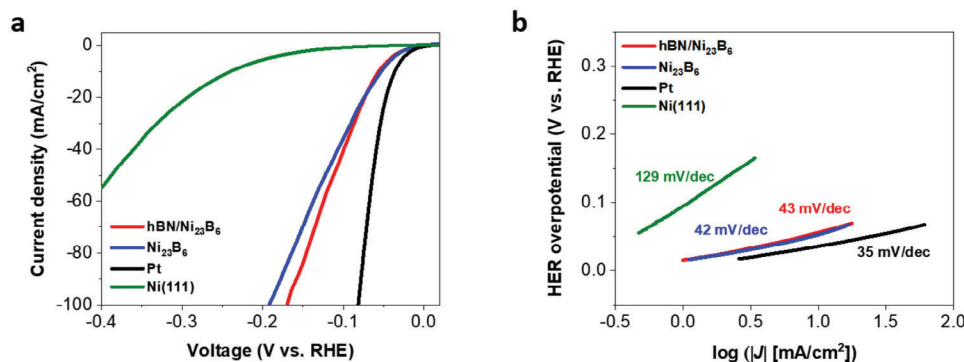


Figure 2. HER catalytic performance of the hBN/ Ni_{23}B_6 /Ni electrode and of other relevant electrodes for comparisons. a) Polarization curves and b) Tafel slopes for hBN/ Ni_{23}B_6 /Ni, Ni_{23}B_6 /Ni, Ni(111) foil, and Pt foil electrodes measured in 0.5-M H_2SO_4 at a scan rate of 5 mV s^{-1} .

Table 1. Comparison of HER activity of hBN/Ni₂₃B₆/Ni, Ni₂₃B₆/Ni, Pt, and Ni as electrodes.

	Potential at 10 mA cm ⁻¹ (mV vs RHE)	Tafel slope (mV dec ⁻¹)	Onset potential (V)
hBN/Ni ₂₃ B ₆ /Ni	52	43	0.025
Ni ₂₃ B ₆ /Ni	52	42	0.025
Pt	36	35	0.005
Ni(111)	240	129	0.103

from hBN-covered Ni₂₃B₆ samples using H₂ plasma treatment (see details in the Experimental Section and Figure S5, Supporting Information). As shown in Figure 2 and Table 1, the HER overpotential of Ni₂₃B₆ is also measured to be 52 mV at a current density of 10 mA cm⁻¹, which is 16 mV higher than that of the Pt electrode under the same testing conditions. Interestingly, the overpotential and Tafel slopes of hBN/Ni₂₃B₆ are almost identical to those of Ni₂₃B₆, which are the best among known nickel-boride catalysts (Table S1, Supporting Information) and various 2D-carbon and metal compound hybrid catalysts (Table S2, Supporting Information).

Our results indicate that the single-crystalline trilayer hBN is catalytically transparent and does not obstruct HER activation. This catalytic transparency has been demonstrated in hBN-covered Cu for the CVD of large-area graphene^[36] and in a hBN-covered OER catalyst.^[39] In the latter report, the catalytic activity of hBN-covered NiFeO_xH_y electrodes demonstrated the electron tunneling effect through atomically thin hBN layers.^[39] Furthermore, the current densities *j* in electron-tunneling devices have previously been shown to be a function of the number of hBN layers.^[40–42] Fast electron tunneling should be possible through trilayer hBN; it enables electron transfer between the catalyst and electrolyte to not be disturbed by the encapsulation layer, allowing its catalytic transparency. To further explore the effect of the hBN layer and its thickness dependency, we measured the HER activity of transferred trilayer hBN/Ni and as-grown 3 nm-thick (≈9-layer) hBN/Ni (Figure S6 and Table S3, Supporting Information). Note that we used hBN/Ni samples instead of hBN/Ni₂₃B₆/Ni(111) in the control experiments for the effect of the hBN layer and its thickness dependency because we have not yet found the experimental conditions to grow thick hBN on Ni₂₃B₆/Ni(111). The HER activity of transferred trilayer hBN/Ni shows negligible difference compared to the bare Ni substrate, indicating that hBN itself does not exhibit significant HER activity. On the other hand, the 3 nm-thick hBN-covered Ni catalyst shows higher HER overpotential than bare Ni foil. This result demonstrates that relatively thick hBN degrades the catalytic activity of the Ni foil by impeding charge transfer between the Ni foil and the electrolyte. We also measured the active sites of the Ni₂₃B₆ catalyst. The effective electrochemical active surface area (ECSA) of the hBN/Ni₂₃B₆ electrode is measured to be ≈2 cm² (Figure S7, Supporting Information). Furthermore, the estimated density of the surface active sites of Ni₂₃B₆ is comparable to the reported single-crystalline Pt catalyst.^[43] Moreover, the electrochemical impedance spectra of Ni catalysts with and without hBN further support the no different interfacial resistance

introduced by hBN encapsulation (Figure S8, Supporting Information).

Along with electrocatalytic transparency, we found that the hBN encapsulation layer blocks the access of reactive species to the Ni₂₃B₆ surface, preventing degradation. Investigations of the electrochemical stability of the hBN/Ni₂₃B₆/Ni and Ni₂₃B₆/Ni electrodes were carried out over 2000 cycles. The high current density of the hBN/Ni₂₃B₆/Ni electrode shows remarkable long-term stability with negligible differences in the polarization curves and the same overpotential even after 2000 cycles (Figure 3a,c). In contrast, the Ni₂₃B₆/Ni electrode shows noticeable degradation after 650 cycles (Figure 3c). After 2000 cycles, the overpotential degrades significantly to ≈200 mV at a current density of 10 mA cm⁻¹ (Figure 3b), similar to the reference Ni sample (Figure 2a, green). XPS indicates that the peak for the Ni–B bond in the B 1s spectrum disappears after 650 cycles (Figure S9, Supporting Information); we attribute this to the 200 nm-thick Ni₂₃B₆ catalyst layer being etched by the highly reactive environment of the acidic electrolyte. To further investigate the protective effect of hBN, we performed chronoamperometry (CA) studies on the hBN/Ni₂₃B₆/Ni and Ni₂₃B₆/Ni electrodes (Figure 3d). CA evaluates the long-term stability of the current density at a constant potential. Under an overpotential of ≈52 mV, the current density of Ni₂₃B₆ quickly decayed to only ≈67.5% of its original value after 1 h. In contrast, the current density of the hBN/Ni₂₃B₆ catalyst under the same conditions was maintained at ≈95% for 20 h. The enhanced catalytic stability of hBN/Ni₂₃B₆ during the CA test can be attributed to a passivation effect that prevents the catalyst from degradation.

To evaluate whether the morphology of hBN/Ni₂₃B₆ changes during the reaction in acidic electrolytes, we evaluated the surface morphology before and after HER using scanning electron microscopy (SEM; Figure 4a,b). Uniform contrast is revealed on the hBN surface before and after HER for the hBN/Ni₂₃B₆ sample, indicating that the entire Ni₂₃B₆ surface is covered by hBN even after HER. We then used XPS to define the chemical bonding structure of the hBN/Ni₂₃B₆ before the reaction. The spectrum in the binding-energy region of B 1s was deconvoluted into two distinct peaks at 190 and 188 eV, which correspond to the B–N and B–Ni bonds, respectively (Figure 4c). The N 1s spectrum shows a single peak, indicating that only N with N–B bonds are present. All XPS spectra show negligible differences between those before and after HER stability tests (Figure 4d). These experimental results suggest that the hBN encapsulation of the electrochemical catalyst allows the realization of long-term stability within acidic electrolytes (0.5 M H₂SO₄), making them potentially useful to various electrode applications.

According to a recent report, even hBN encapsulation involving a monolayer film can enhance the efficiency of the OER and long-term stability.^[39] This report demonstrated the protective effects of hBN encapsulation through many control experiments; however, the encapsulation layer was transferred from a growth substrate, and the transfer process (physical delamination) may cause many defects such as cracks, holes, and folds. The direct growth of hBN onto electrochemical catalysts, such as in the preparation of hBN/Ni₂₃B₆/Ni, avoids such damage, but direct growth typically requires high temperatures that are well above ≈1000 °C; therefore, it is desirable for future efforts to develop a versatile method capable of growing highly crystalline

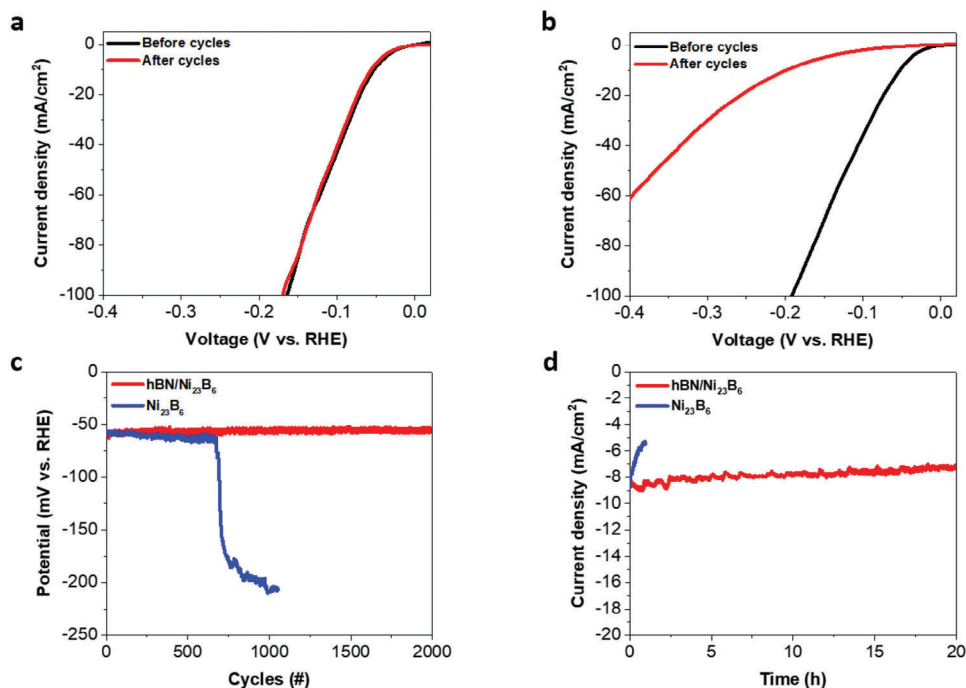


Figure 3. Electrochemical stability tests of the hBN/Ni₂₃B₆/Ni and Ni₂₃B₆/Ni electrodes. (a,b) Polarization curves before (black curve) and after (red) 2000 cycles for the a) hBN/Ni₂₃B₆/Ni and b) Ni₂₃B₆/Ni electrodes. c) Results of a long-term stability test of Ni₂₃B₆ with and without hBN. d) Chronoamperometry measurements of the hBN/Ni₂₃B₆/Ni and Ni₂₃B₆/Ni electrodes under an overpotential of 52 mV.

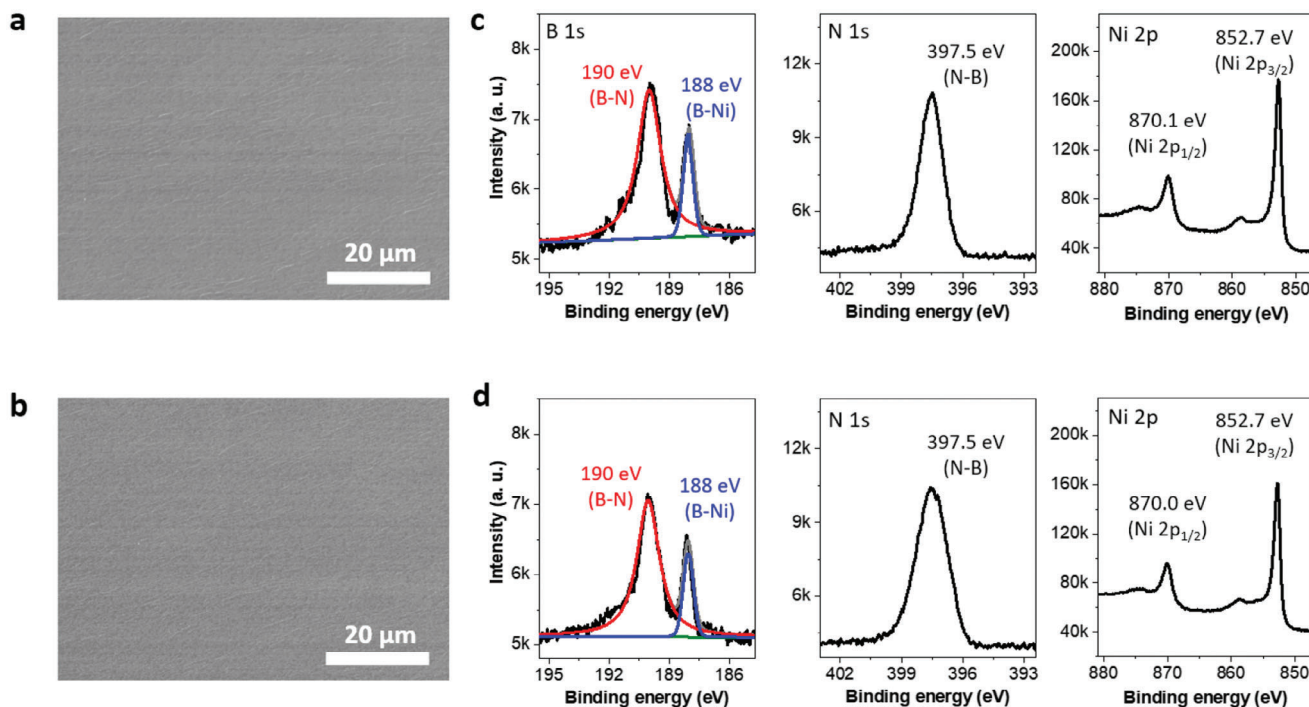


Figure 4. Stability of hBN/Ni₂₃B₆/Ni electrodes with respect to HER. (a,b) SEM images of hBN/Ni₂₃B₆ surface a) before and b) after HER. c) XPS of the as-fabricated hBN/Ni₂₃B₆/Ni electrode. The two peaks in the binding-energy region of B 1s appear at 190.0 eV (B–N) and 188.0 eV (B–Ni). In the N 1s region, one peak appears at 397.5 eV (N–B). The Ni 2p spectrum shows metallic Ni peaks at 870.1 eV and 852.7 eV. d) XPS spectra of the hBN/Ni₂₃B₆/Ni electrode after HER tests, revealing the electrode did not change.

hBN layers on various electrochemical catalysts for practical applications.

In summary, we have presented both HER electrocatalytic activity and stability of Ni₂₃B₆ in an acidic solution. Its poor HER stability was highly improved through its encapsulation by a hBN layer, which acts as an electrocatalytic transparent layer, preserving the HER activity of Ni₂₃B₆. Electrochemical long-term stability tests show a maintained polarization curve for 2000 cycles and a stable chronoamperometric curve for 20 h. Furthermore, the morphology and chemical structure are maintained after long-term HER tests. Our results indicate that the hBN encapsulation can be utilized to dramatically enhance the stability of electrochemical catalysts without performance degradation.

3. Experimental Section

Preparation of Single-Crystalline Ni(111) Foil: The Ni(111) foil was prepared by contact-free annealing. A suspended commercial polycrystalline Ni foil (100 μm thick, 99.994%) was heated to 1350 °C, and held at that temperature for 24 h under a mixed-gas flow (Ar, 30 sccm; H₂, 30 sccm; sccm, standard cubic centimeters per minute) at a pressure of 760 torr.

Fabrication of Ni₂₃B₆ Cathode Covered by Single-Crystalline Trilayer hBN, hBN/Ni₂₃B₆/Ni: The annealed Ni(111) foil was placed inside a high-temperature and low-pressure CVD system at the center of a furnace. A borazine precursor flask was placed in a bath of ethylene glycol and water at -15 °C. The bath temperature was ramped up to 25 °C, and the Ni(111) foil was heated to a growth temperature of 1220 °C under a mixed-gas flow (Ar, 10 sccm; H₂, 10 sccm). The flow of borazine gas at 0.1 sccm (controlled by a mass flow controller) was then introduced into the CVD chamber for 60 min. After hBN growth, the borazine flow was terminated, and the furnace was cooled rapidly to room temperature under a mixed-gas flow (Ar, 10 sccm; H₂, 10 sccm). Ni₂₃B₆ forms during the cool down, resulting in hBN/Ni₂₃B₆/Ni.

Transfer of hBN Films onto Arbitrary Substrates: The as-grown hBN was transferred from Ni₂₃B₆/Ni to SiO₂/Si wafers by a polymer-mediated wet-transfer process for further characterization. In this process, a poly(methyl methacrylate) (PMMA) film was spin-coated on the as-grown hBN/Ni₂₃B₆/Ni as a protective layer. Then, Ni₂₃B₆/Ni was etched away in an aqueous solution of iron chloride (FeCl₃). After thorough washing, the hBN film was transferred to the target substrate, and finally, the PMMA was removed by dipping it in acetone.

Removal of the hBN Layer from the hBN/Ni₂₃B₆/Ni Sample using H₂ Plasma Etching: To evaluate the electrocatalytic performance of Ni₂₃B₆ without the protective hBN layer, the as-grown hBN/Ni₂₃B₆/Ni sample was exposed to 50 W of H₂ plasma using a 13.56-MHz radio-frequency plasma generator (Diener Femto, Diener Electronic) for 5 min. The sample was kept 10 cm away from the discharge zone. Plasma treatment was performed at 25 °C with an H₂ gas flow (5 sccm). The operating pressure was maintained at 1 mbar during plasma exposure. No potential was applied to the aluminum stage on which the sample was placed.

Characterization Techniques: The prepared Ni(111) foil was characterized by SEM (Verios 460, FEI) and electron-backscatter diffraction (Hikari from Ametek). The surface morphology of hBN was characterized by optical microscopy (Axio Scope. A1, Carl Zeiss), SEM (Verios 460, FEI), and AFM (Dimension Icon, Bruker). Typical conditions of 5.0 kV and 0.8 μA were adapted for all SEM images. XPS (ESCALAB 250 Xi, Thermo Scientific) was performed to determine chemical compositions. Note that the 20.0 eV of pass energy and 0.05 eV of energy step size were adapted for the precise XPS measurements. Raman spectra were obtained using a micro-Raman spectrometer (alpha 300, WITec GmbH) with a laser excitation wavelength of 532 nm and power of ≈2 mW. For atomic-resolution TEM and STEM imaging, a spherical aberration (Cs)-corrected TEM (Titan³ G2 60–300, FEI) was used at 80 and 200 kV, respectively.

Electrochemical Measurements: Electrochemical measurements were performed in a three-electrode cell using a ZIVE SP2 (ZIVE LAB).

Polarization curves were collected by linear-sweep voltammetry with a scan rate of 5 mV s⁻¹ in 0.5 M H₂SO₄ electrolyte. A square metal-foil electrode of geometric area 1 cm × 1 cm was used as the working electrode and set up in a customized holder for measurements. Ag/AgCl and graphite rod were used as the reference electrode and counter electrode, respectively. During electrochemical measurements, high-purity N₂ gas was continuously bubbled. Potentials versus RHE can be calculated and compared with the Ag/AgCl electrode by adding a value of 0.215 V after calibration. The electrochemical stabilities of the catalysts were evaluated by continuously cycling the catalyst at a scan rate of 5 mV s⁻¹, for up to 2000 cycles. The chronoamperometry measurements were done after stabilization for 7 h.

Supporting Information

Supporting Information is available from the Wiley Online Library or from the author.

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Conflict of Interest

The authors declare no conflict of interest.

Author Contributions

H.S.S. and K.Y.M. conceived the project. K.Y.M. grew the hBN and Ni₂₃B₆ by CVD, fabricated the electrochemical electrodes, and carried out optical microscopy, SEM, AFM, and Raman measurements. H.K. and H.H. carried out XPS measurements. K.Y.M., H.H., D.S.J., H.J.L., K.C., and J.Y. performed electrochemical measurements. H.Y.J. performed TEM and STEM measurements. H.S.S. supervised this project. All authors contributed to writing of the manuscript.

Data Availability Statement

The data that support the findings of this study are available from the corresponding author upon reasonable request.

Keywords

catalytic transparency, electrochemical catalysts, hexagonal boron nitride, hydrogen evolution reaction, metal boride

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